



NOTES:

MATERIAL :

- |                    |  |
|--------------------|--|
| 1.HOUSING MATERIAL | :GLASS FILLED POLYESTER UL94V-0.                   |
| 2.CONTACT MATERIAL | :PHOSPHOR BRONZE $\phi$ 0.46mm.                    |
| 3.PLATING          | :GOLD PLATING OVER NICKEL.                         |
| 4.SHIELD           | :0.20mm THICKNESS COPPER ALLOY WITH NICKEL PLATED. |

ELECTRICAL:

- |                                      |                              |
|--------------------------------------|------------------------------|
| 1.VOLTAGE RATING                     | :125 VAC RMS.                |
| 2.CURRENT RATING                     | :1.5 AMP.                    |
| 3.CONTACT RESISTANCE                 | :30 MILLIOHMS MAX.           |
| 4.INSULATION RESISTANCE              | :500 MEGOHMS MIN @ 500V DC . |
| 5.DIELECTRIC WITHSTANDING RESISTANCE | :1000V AC RMS 50Hz. 1MIN.    |

MECHANICAL:

- |                            |                  |
|----------------------------|------------------|
| 1.DURRABILITY              | :750 CYCLES MIN. |
| 2.PCB RETENTION PRE-SOLDER | :1 LB. MIN.      |

ENVIRONMENTAL:

- |              |                |
|--------------|----------------|
| 1. STORAGE   | : -40°C~+85°C  |
| 2. OPERATION | : 0°C TO 70°C. |

PART NUMBER:

PC Board Layout  
Component Side Shown



RoHS Compliant		<b>SCHMID-M</b>	
APPD.		TOLERANCE	PART NAME
DWG. HELEN	SCALE	0 ± 0.38 .00 ± 0.25 ANG. ± 3°	SIDE ENTRY PCB JACK ROUND PIN 8P8C 8 JACKS SHIELDED BLACK ROHS
DATE 2013/05/16	UNIT M M	SIZE. A 4	PART NO.
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